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PATENT

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of:

Luo et al.

Serial No.: 10/826,985

Filed: April 19, 2004

For: METHODS FOR FORMING  
PROTECTIVE LAYERS ON  
SEMICONDUCTOR DEVICE  
COMPONENTS SO AS TO REDUCE OR  
ELIMINATE THE OCCURENCE OF  
DELAMINATION THEREOF AND  
CRACKING THEREIN

Confirmation No.: Unknown

Examiner: Unknown

Group Art Unit: Unknown

Attorney Docket No.: 2269-5565.1US

CERTIFICATE OF MAILING

I hereby certify that this correspondence along with any attachments referred to or identified as being attached or enclosed is being deposited with the United States Postal Service as First Class Mail on the date of deposit shown below with sufficient postage and in an envelope addressed to the Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450.

July 16, 2004  
Date

  
Signature

Rachael M. Harris  
Name (Type/Print)

PRELIMINARY AMENDMENT

Mail Stop Amendment  
Commissioner for Patents  
P.O. Box 1450  
Alexandria, Virginia 22313-1450

Sir:

Prior to examination of the above-referenced patent application on the merits, entry of the amendments as set forth herein is respectfully solicited.

**Amendments to the Specification** begin on page 2 of this paper.

**Amendments to the Claims** are reflected in the listing which begins on page 3 of this paper.

**Remarks** begin on page 8 of this paper.